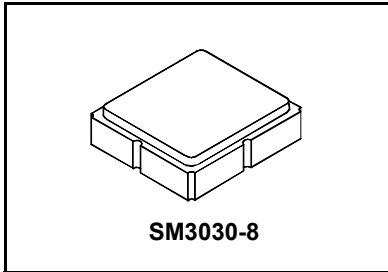


**SF2177E**

**1472 MHz SAW Filter**



• **Low-loss UHF SAW Filter**

**Characteristics:**

Single-ended source impedance :  $Z_S = 50 \Omega$   
Balanced load impedance :  $Z_L = 100 \Omega$

**Maximum Rating**

Rating	Value	Units
Input Power Level	+10	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Tape and Reel Storage Temperature Range	-40 to +85	°C
Component Storage Temperature Range	-50 to +95	°C
Solder Reflow Temperature, 10 seconds/5 cycles maximum	260	°C

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	$f_C$			1472		MHz
Insertion Loss, 1452 to 1492 MHz	IL			3.2	4.5	dB
Amplitude Ripple, 1452 to 1492 MHz				1.0	2.0	
Group Delay Ripple, 1452 to 1492 MHz				8	40	ns <sub>p-p</sub>
Input Return Loss, 1452 to 1492 MHz			6.5	8.0		dB
Output Return Loss, 1452 to 1492 MHz			8.8	10.5		
Attenuation, 0 dB Reference:						dB
880 to 915 MHz			50	54		
1410 MHz			30	35		
1530 to 1570 MHz			15	29		
1575 MHz			30	38		
1710 to 1785 MHz			35	40		
1920 to 1980 MHz			35	37.5		
2400 to 2500 MHz			26	31.5		

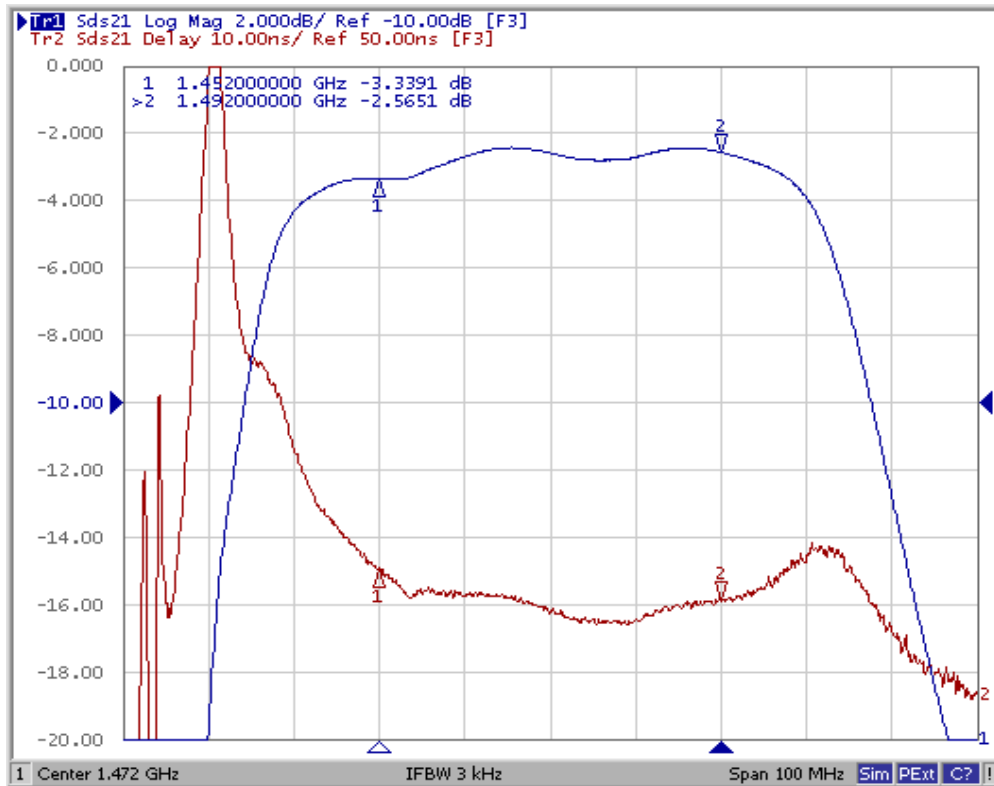
Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint	
Lid Symbolization, Y=year, WW=week, S=shift, dot=pin 1 indicator	866, YWWS	
Standard Reel Quantity	Reel Size 7 inch	500 Pieces/Reel
	Reel Size 13 inch	3000 Pieces/Reel



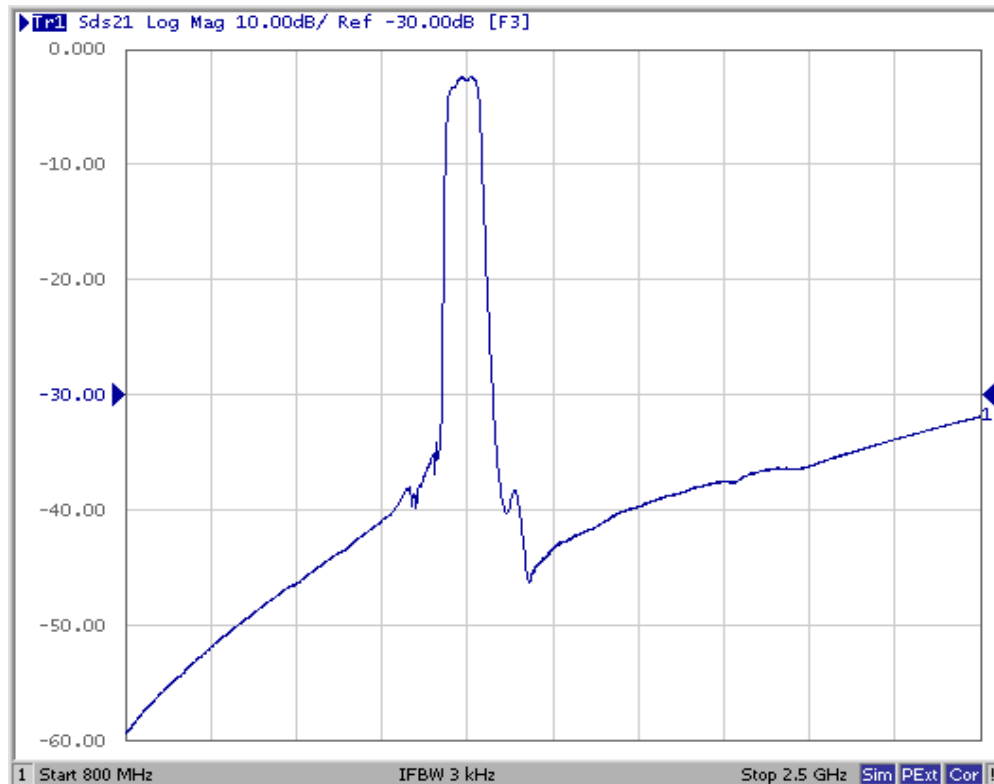
**NOTES:**

1. US and international patents may apply.
2. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.
3. Electrostatic Sensitive Device. Observe precautions for handling.

## Filter Passband Amplitude and Group Delay Plots



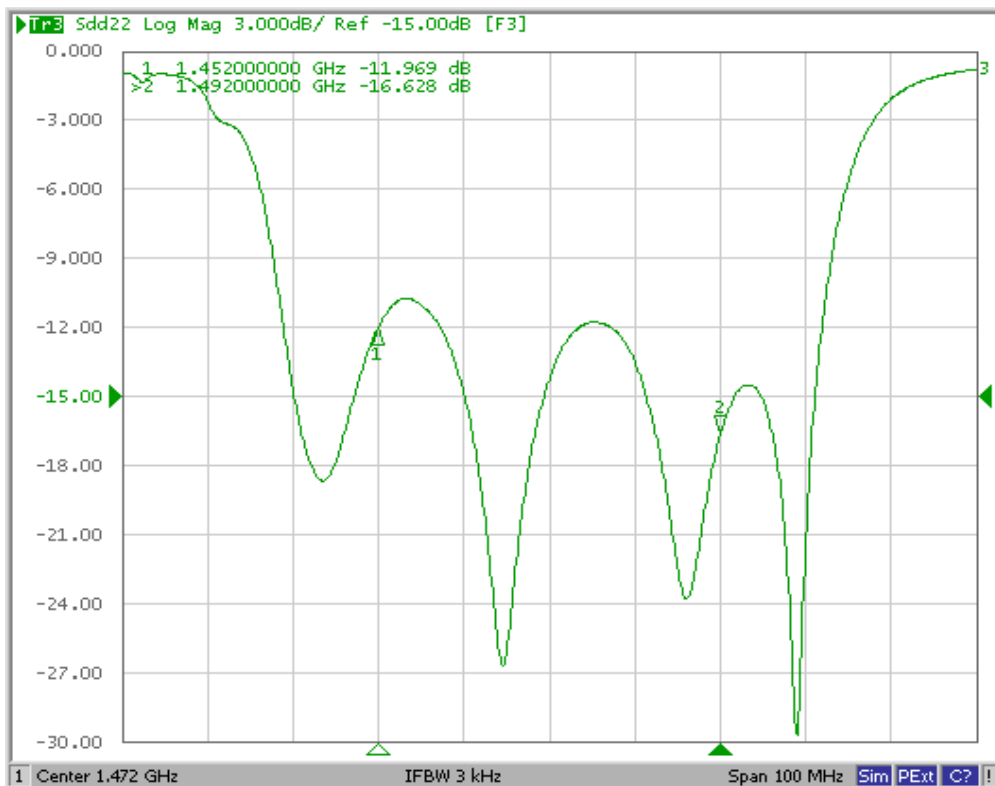
## Filter Broadband Plot



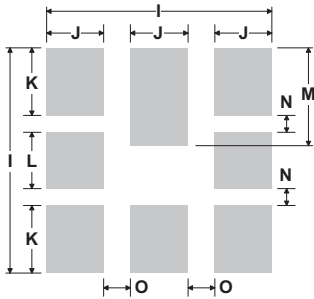
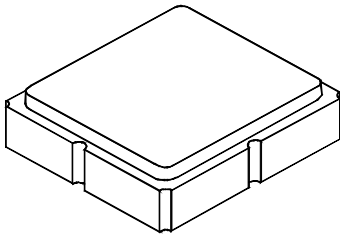
## Filter Input Return Loss



## Filter Output Return Loss



## 8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



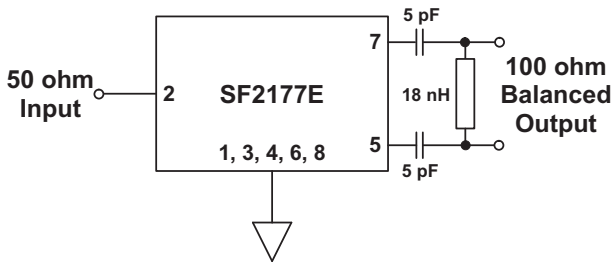
PCB Footprint Top View

Case and PCB Footprint Dimensions

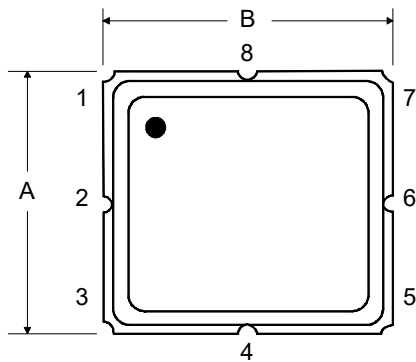
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	-	-	1.10	-	-	0.043
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
H	1.07	1.20	1.33	0.042	0.047	0.052
I		3.19			0.126	
J		0.81			0.032	
K		0.96			0.038	
L		0.81			0.032	
M		1.39			0.055	
N		0.23			0.009	
O		0.38			0.015	

Case Materials

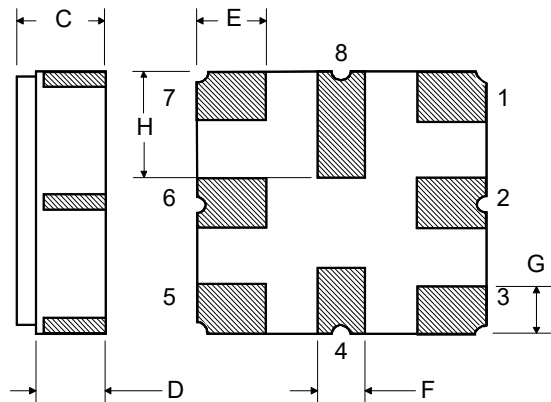
Materials	
Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
	Pb Free



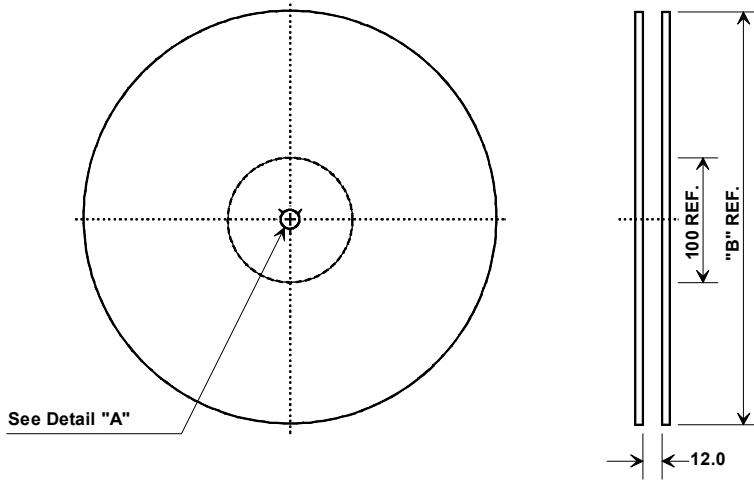
TOP VIEW



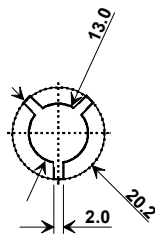
BOTTOM VIEW



# Tape and Reel Specifications



"B"		Quantity Per Reel
Nominal Size		
Inches	millimeters	
7	178	500
13	330	3000



Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.4 mm
Pitch	8.0 mm
W	12.0 mm

## COMPONENT ORIENTATION and DIMENSIONS

